

Inolux Surface Mount LEDs Data Sheet IN-150UF5

Official Product	IN-150UF5	Your Part No.		Data Sheet No.
		******		IN-150UF5
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DISCLAIMER

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LIFE SUPPORT POLICY

INOLUX's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specification

	Specification	Material	Quantity
lv	Iv=35mcd typ.		
	@5mA/ Ts= 25°C; Tolerance: ±11%		
Chromaticity	X: 0.41, Y: 0.20		
Coordinate	@5mA/ Ta= 25O C; Tolerance: ±0.005		
Vf	Vf=2.7-3.3V		
	$@5mA/Ts=25^{\circ}C$; Tolerance: $\pm 0.02V$		
Ir	< 100 µA @ VR = 5 V		
Resin	Diffused	Epoxy Resin	
Carrier tape	EIA 481-1A specs	Conductive black tape	3000pcs/reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

ATTENTION: Electricstatic Discharge (ESD) protection



The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built

with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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Label Spec.



Inolux P/N

I N - 1 5 0 U F 5 - X X X X

Series Name	Emitting Color	Custom code
IN-150:	UF:	XXXX
3.2x1.5x1.1mm	Pink	Customer product code
	5:	
	@5mA	

Lot No.

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	
Internal Tracing Co	2010-A 2011-B 2012-C 2013-D	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	~77		000~ZZZ	

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Intensity Bin (Iv)

Bin	Min.	Max.	Unit	Condition
H1	28.5	35.0		
H2	35.0	45.0	mcd	If=5mA
J1	45.0	56.0		

Notes: Tolerance of Luminous Intensity: ±11%

Forward Voltage Bin (Vf)

Bin	Min.	Max.	Unit	Condition	
5B	2.7	2.8			
6A	2.8	2.9			
6B	2.9	3.0	V	If=5mA	
7A	3.0	3.1			
7B	3.1	3.2			
8A	3.2	3.3			

Notes: Tolerance of Forward Voltage: $\pm 0.02V$

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Color Bin

	0.3599	0.1996		0.3745	0.2086
	0.3699	0.1808		0.3845	0.1898
L6	0.3845	0.1898	L8	0.3991	0.1988
	0.3745	0.2086		0.3891	0.2176
	0.3599	0.1996		0.3745	0.2086
	0.3891	0.2176	M3	0.4037	0.2266
	0.3991	0.1988		0.4137	0.2078
M1	0.4137	0.2078		0.43	0.2178
	0.4037	0.2266		0.42	0.2366
	0.3891	0.2176		0.4037	0.2266
	0.42	0.2366		0.4363	0.2466
	0.43	0.2178		0.4463	0.2278
M5	0.4463	0.2278	M7	0.4613	0.2378
	0.4363	0.2466		0.4513	0.2566
	0.42	0.2366		0.4363	0.2466

Notes: Tolerance of ± 0.007

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Chromaticity Coordinate



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Product Characteristics

lectro-Optical Characteristics								
(I _F @ 5mA, T _a 25 °C)								
Product No.	Color	V _F (V)	Chromaticity Coordinate	I	• _v (mcd	l)	Viewing Angle
FIGULE NO.	COIOI	Min.	max	Χ, Υ	Min	Тур.	Max.	20 2/1
IN-150UF5	Pink	2.7	3.3	X: 0.41 , Y: 0.20	28.5	35	56	120
Dor NIST standards								

* Per NIST standards

Package Outline Dimension



Absolute Maximum Ratings							
						(T _a 25 °C)	
Series	P _d (mW)	I _F (mA)	I _{FP} (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	
IN-150UF5	75	25	100	5	-30~+85	-40~+90	

* Condition for $I_{\mbox{\scriptsize FP}}$ is pulse of 1/10 duty and 0.1msec width

**Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product,

such operation can cause migration resulting in LED damage.

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Packaging Tape, Reel, and Packing Model Tape Dimension



Reel Dimension



Unit: mm Tolerance: +/-0.15 mm

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Packing Model



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Precaution of Application

Designing 1: Soldering pattern

The dimensions of the recommended soldering pattern may not meet every user. Please confirm and study first before designing the soldering pattern in order to obtain the best performance of soldering.

Designing 2: Circuit layout

Due to the circuit design is not available, assuming the circuit is in parallel and a resistor that is put in series in the circuit, it cannot provide an effective current-limiting function to the LEDs due to each LED had a different inherent resistance. In general, the LEDs usually have a different inherent resistance. Different inherent resistance will cause different current, the LED on the different path would be driven at different power, and the result was the LED with a higher resistance would be dimmer than the other. To solve this situation, a suitable resistor is put in series with each LED to limit the current disparity through the LED will be very useful.

Designing 3: Max Rating

Any application should refer to the specifications of absolute maximum ratings.

Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment. By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

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Storage

It's recommended to store the products in the following conditions: Humidity: 60 %RH Max. Temperature: 5°C ~30°C (41°F~86°F)

- Shelf life in sealed bag: 12 month at<40°C and <90%RH. (Base on aluminum laminated moisture barrier bag.)
- 2. After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
 - 2.1 Mounted within 72 hours at factory conditions of $\leq~30^\circ\text{C}$ /60% RH, or
 - 2.2 Stored at \leq 20% RH with zip-lock sealed.

Baking

It's recommended to bake before soldering once the pack is unsealed open & re-sealed after 72 hours. The conditions are as followings: $60 \pm 3^{\circ}C \times (12 - 24hrs)$ and < 5% RH, taped reel type $100\pm 3^{\circ}C \times (45min - 1hr)$, bulk type $130\pm 3^{\circ}C \times (15 - 30min)$, bulk type

Soldering

Manual soldering (We do not recommend this method strongly.)

Soldering wire: 63/37 Sn/Pb, flux contained.

To prevent cracking, please bake before manual soldering, if the device is subject to moisture. Temperature at tip of soldering tool: $300^{\circ}C\pm5^{\circ}C$ Max.(25W)

It's banned to load any stress on the resin during soldering.

Soldering time: 3±1sec

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Handling of Silicone Resin LEDs

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.





In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.





When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

This is assured by choosing a pick and place nozzle which is large than LEDs reflector area.

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Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220°C, 60 sec.
- 2. Peak temp.:260°C Max., 10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile

Recommended Reflow Profile



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Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^oC max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release IN-150UF5		V1.0	05/07/2014
Format Adjustment		V1.1	02/24/2016

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